

74AUP2G157

Low-power 2-input multiplexer

Rev. 4 — 30 July 2010

Product data sheet

1. General description

The 74AUP2G157 is a single 2-input multiplexer which select data from two data inputs (I_0 and I_1) under control of a common data select input (S). The state of the common data select input determines the particular register from which the data comes. The output (Y , \bar{Y}) presents the selected data in the true (non-inverted) and complement form. The enable input (\bar{E}) is active LOW. When \bar{E} is HIGH, the output Y is forced LOW and the output \bar{Y} is forced HIGH regardless of all other input conditions.

Schmitt trigger action at all inputs makes the circuit tolerant to slower input rise and fall times across the entire V_{CC} range from 0.8 V to 3.6 V. This device ensures a very low static and dynamic power consumption across the entire V_{CC} range from 0.8 V to 3.6 V.

This device is fully specified for partial power-down applications using I_{OFF} . The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

2. Features and benefits

- Wide supply voltage range from 0.8 V to 3.6 V
- High noise immunity
- Complies with JEDEC standards:
 - ◆ JESD8-12 (0.8 V to 1.3 V)
 - ◆ JESD8-11 (0.9 V to 1.65 V)
 - ◆ JESD8-7 (1.2 V to 1.95 V)
 - ◆ JESD8-5 (1.8 V to 2.7 V)
 - ◆ JESD8-B (2.7 V to 3.6 V)
- ESD protection:
 - ◆ HBM JESD22-A114F Class 3A exceeds 5000 V
 - ◆ MM JESD22-A115-A exceeds 200 V
 - ◆ CDM JESD22-C101E exceeds 1000 V
- Low static power consumption; $I_{CC} = 0.9 \mu A$ (maximum)
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of V_{CC}
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



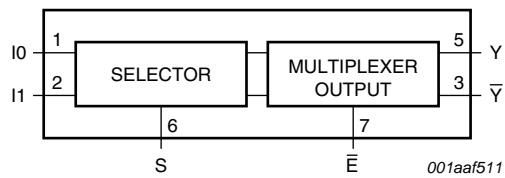


Fig 3. Logic diagram

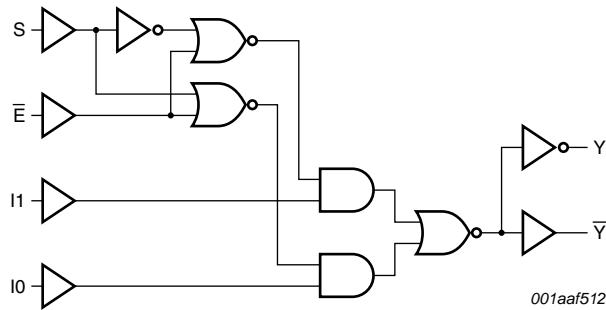


Fig 4. Functional diagram

6. Pinning information

6.1 Pinning

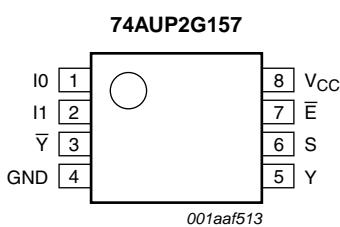


Fig 5. Pin configuration SOT765-1

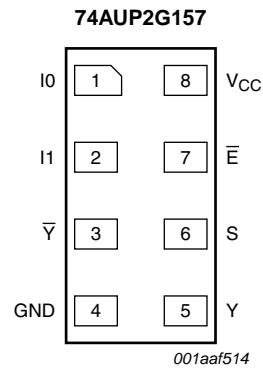


Fig 6. Pin configuration SOT833-1, SOT1089, SOT1116 and SOT1203

13. Package outline

VSSOP8: plastic very thin shrink small outline package; 8 leads; body width 2.3 mm

SOT765-1

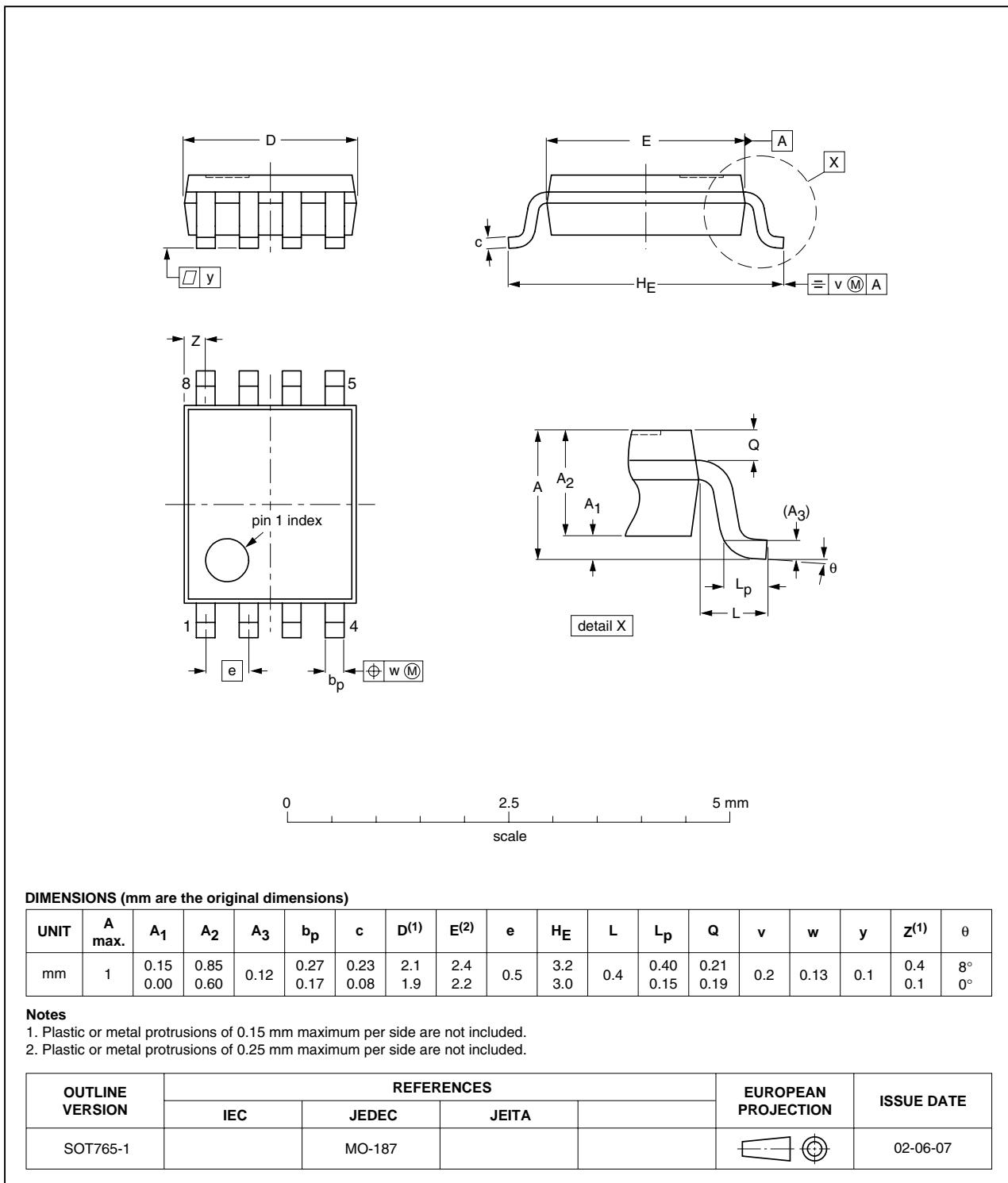


Fig 12. Package outline SOT765-1 (VSSOP8)

XSON8: plastic extremely thin small outline package; no leads; 8 terminals; body 1 x 1.95 x 0.5 mm

SOT833-1

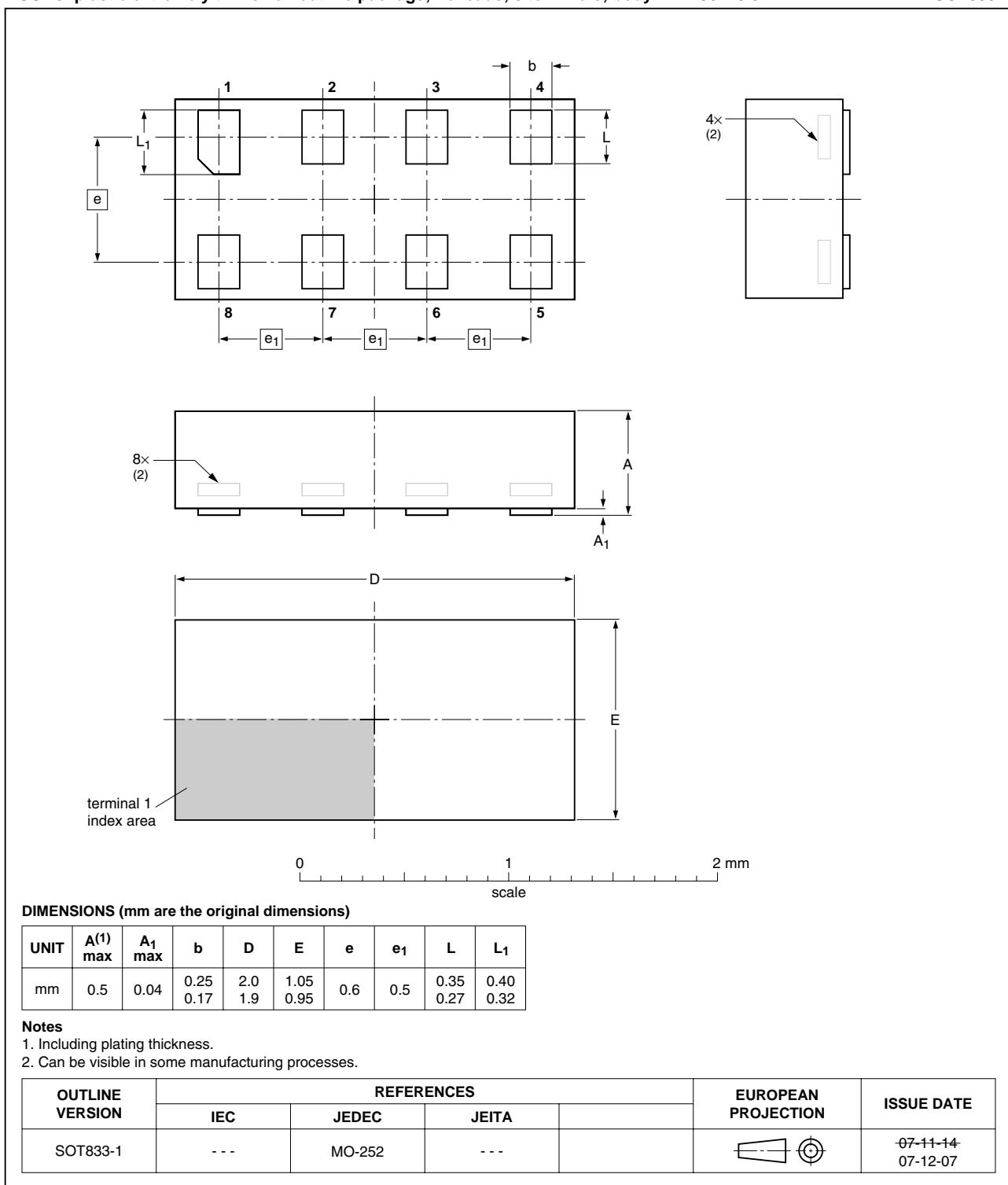


Fig 13. Package outline SOT833-1 (XSON8)

**XSON8: extremely thin small outline package; no leads;
8 terminals; body 1.35 x 1 x 0.5 mm**

SOT1089

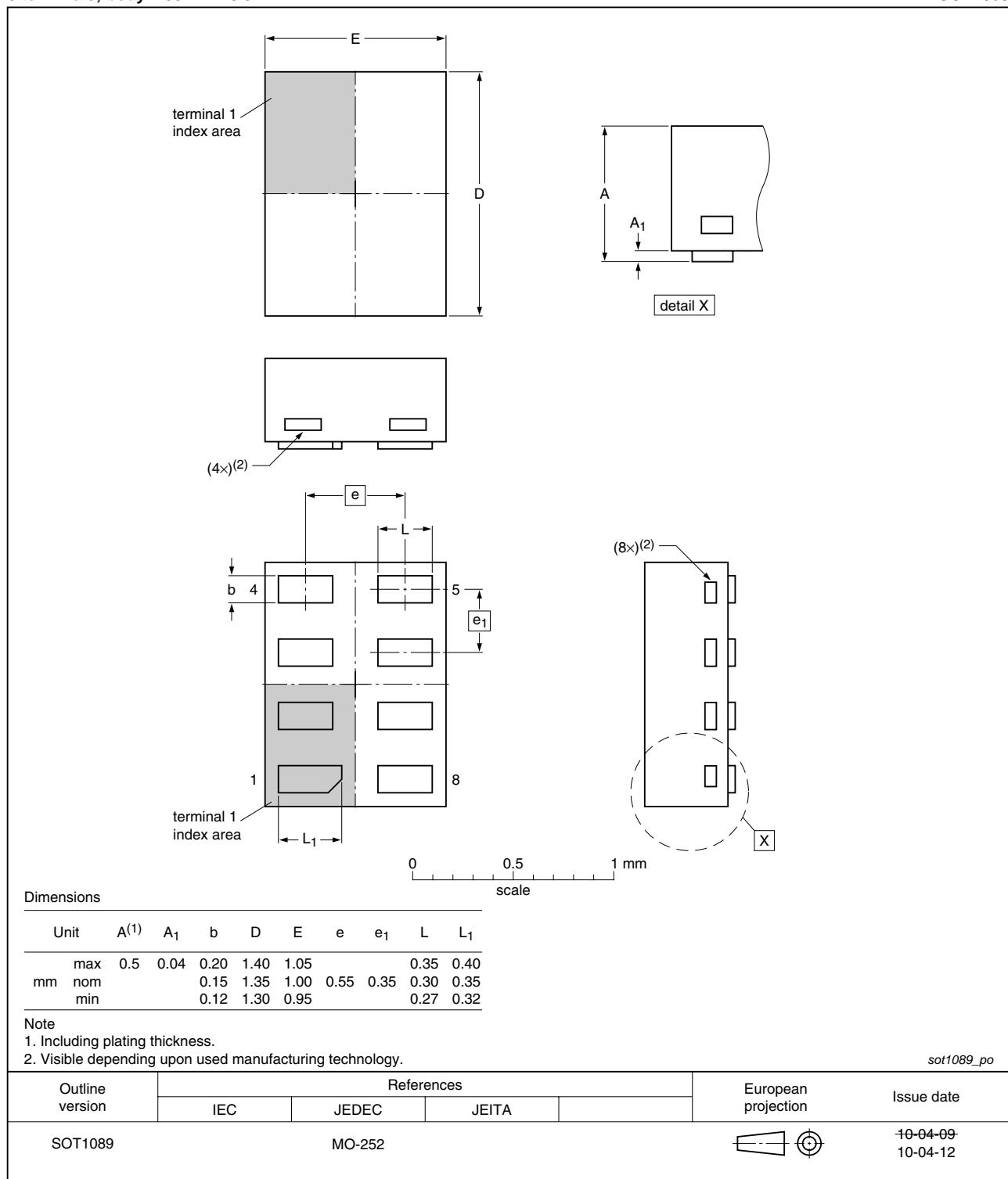


Fig 14. Package outline SOT1089 (XSON8)

XSON8U: plastic extremely thin small outline package; no leads;
8 terminals; UTLP based; body $3 \times 2 \times 0.5$ mm

SOT996-2

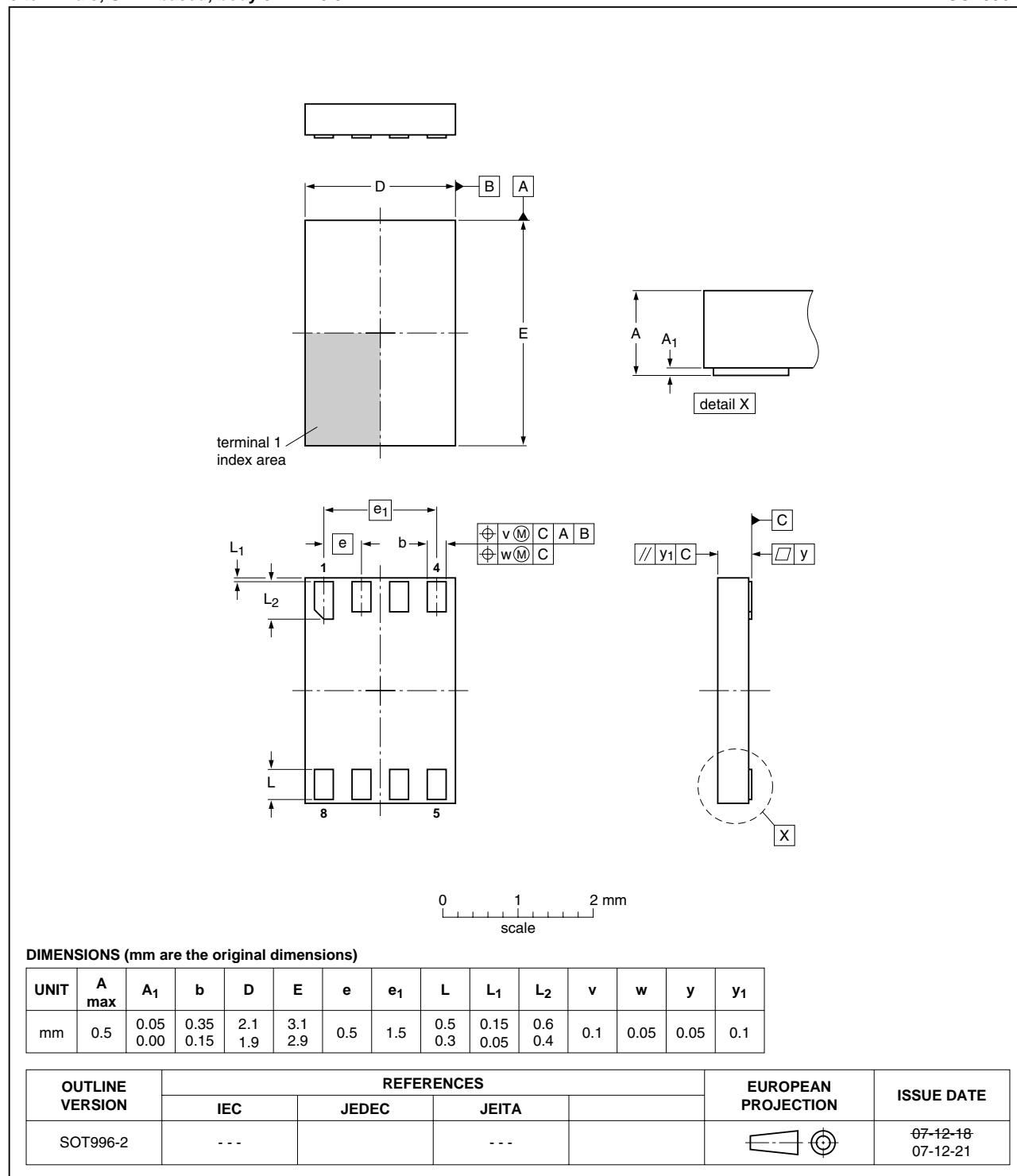


Fig 15. Package outline SOT996-2 (XSON8U)

XQFN8U: plastic extremely thin quad flat package; no leads;
8 terminals; UTLP based; body 1.6 x 1.6 x 0.5 mm

SOT902-1

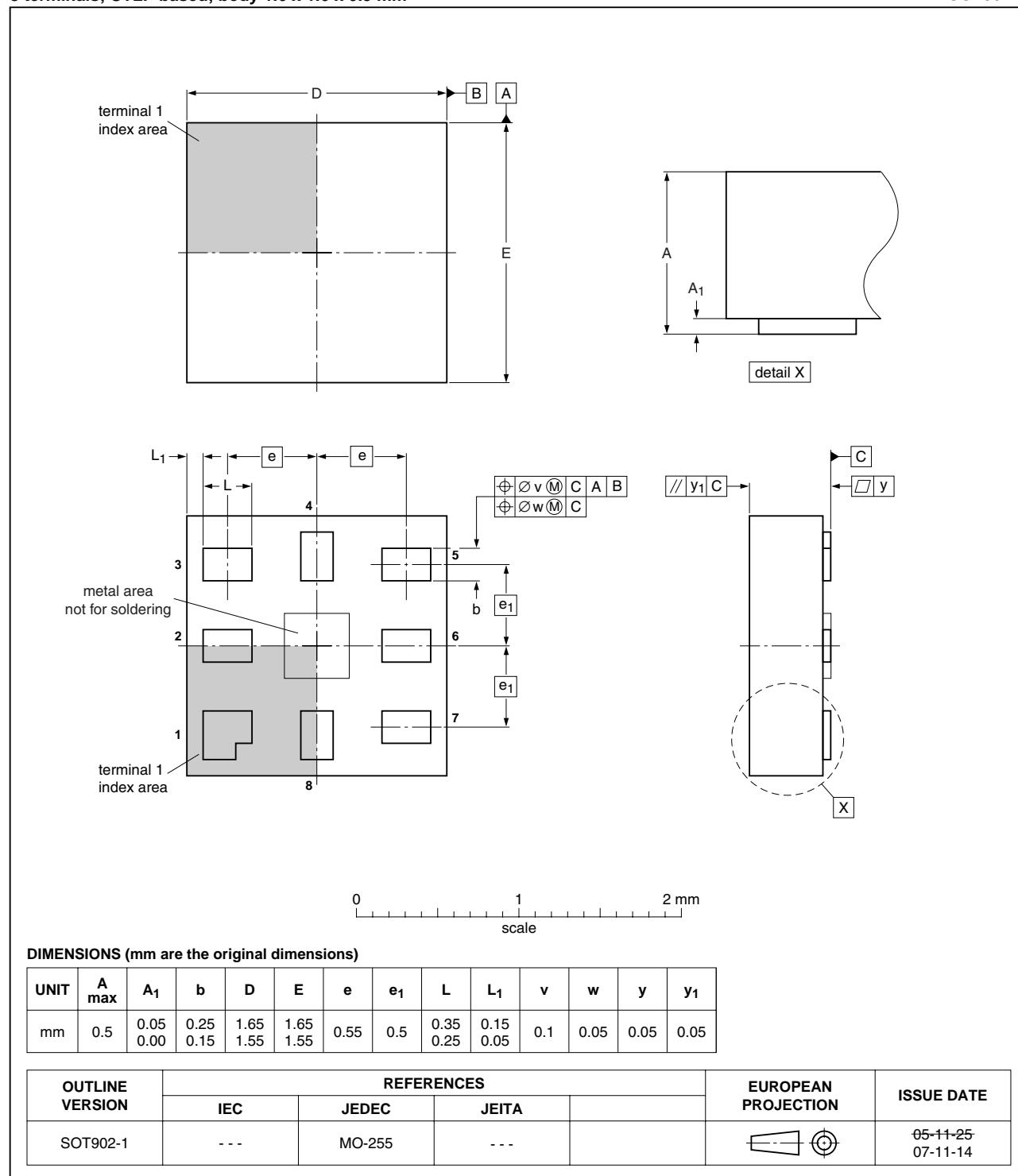


Fig 16. Package outline SOT902-1 (XQFN8U)

XSON8: extremely thin small outline package; no leads;
8 terminals; body 1.2 x 1.0 x 0.35 mm

SOT1116

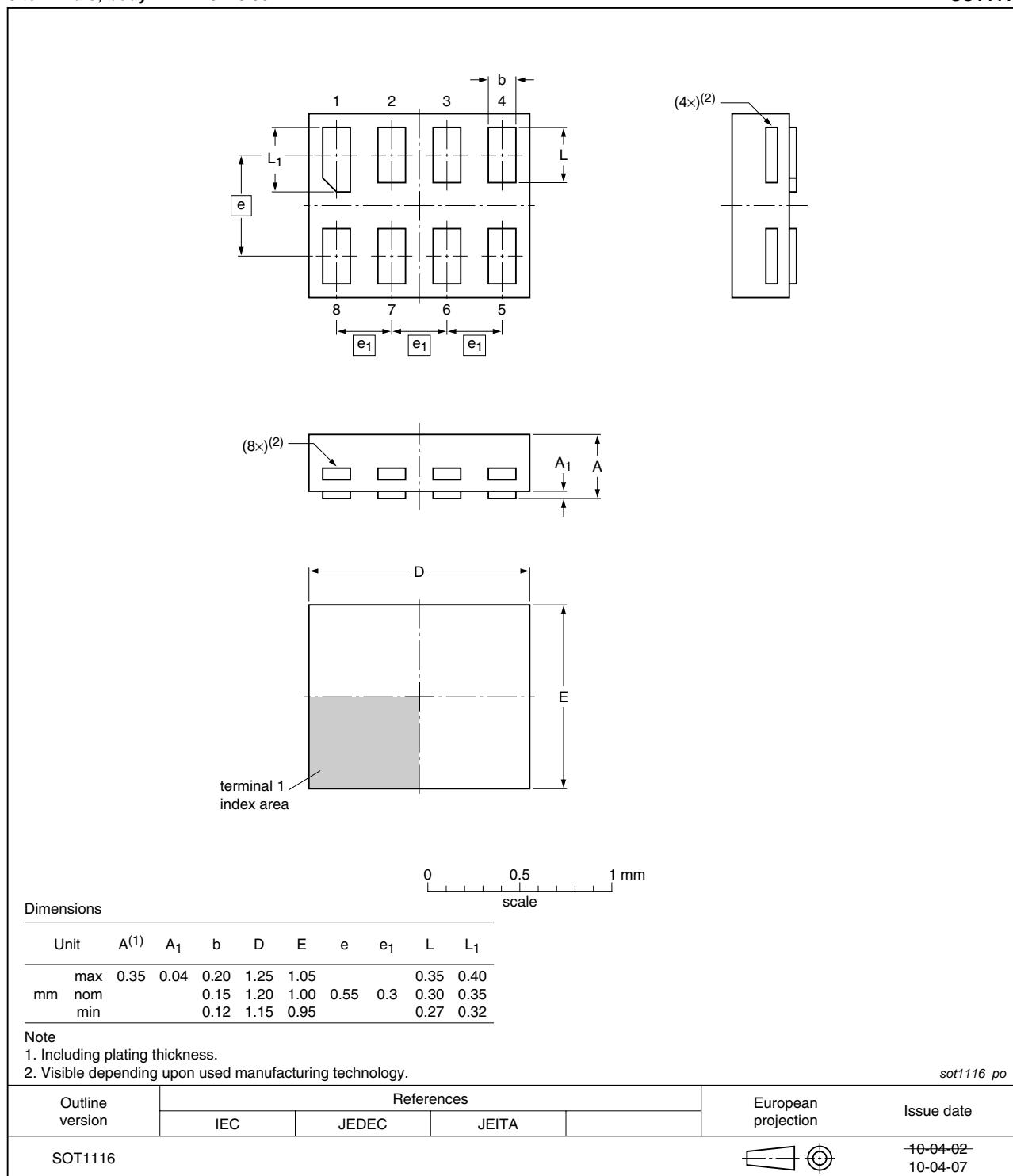
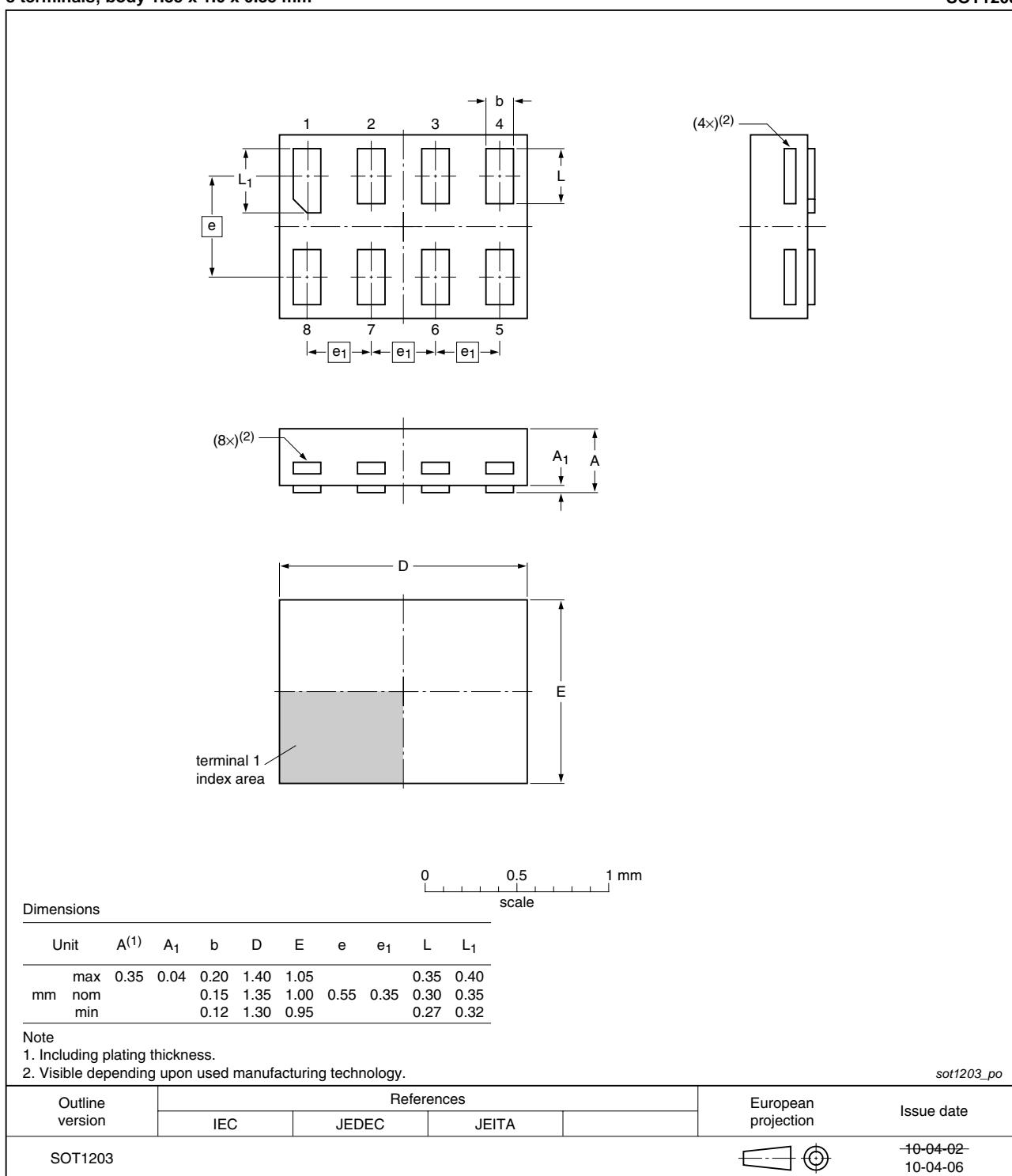


Fig 17. Package outline SOT1116 (XSON8)

**XSON8: extremely thin small outline package; no leads;
8 terminals; body 1.35 x 1.0 x 0.35 mm**

SOT1203

**Fig 18. Package outline SOT1203 (XSON8)**

14. Abbreviations

Table 11. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model

15. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74AUP2G157 v.4	20100730	Product data sheet	-	74AUP2G157 v.3
Modifications:			<ul style="list-style-type: none">• Added type number 74AUP2G157GF (SOT1089/XSON8 package).• Added type number 74AUP2G157GN (SOT1116/XSON8 package).• Added type number 74AUP2G157GS (SOT1203/XSON8 package).	
74AUP2G157 v.3	20080702	Product data sheet	-	74AUP2G157 v.2
74AUP2G157 v.2	20080219	Product data sheet	-	74AUP2G157 v.1
74AUP2G157 v.1	20061006	Product data sheet	-	-

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